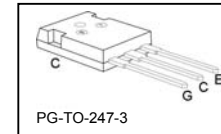
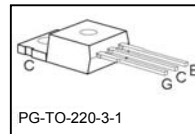
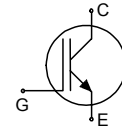


## Fast IGBT in NPT-technology

- 75% lower  $E_{off}$  compared to previous generation combined with low conduction losses
- Short circuit withstand time – 10  $\mu$ s
- Designed for:
  - Motor controls
  - Inverter
- NPT-Technology for 600V applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability



- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>

| Type     | $V_{CE}$ | $I_C$ | $V_{CE(sat)}$ | $T_j$ | Marking | Package       |
|----------|----------|-------|---------------|-------|---------|---------------|
| SGP20N60 | 600V     | 20A   | 2.4V          | 150°C | G20N60  | PG-TO-220-3-1 |
| SGW20N60 | 600V     | 20A   | 2.4V          | 150°C | G20N60  | PG-TO-247-3   |

### Maximum Ratings

| Parameter   | Symbol            | Value      | Unit             |
|---|-------------------|------------|------------------|
| Collector-emitter voltage   | $V_{CE}$          | 600        | V                |
| DC collector current  | $I_C$             |            | A                |
| $T_C = 25^\circ\text{C}$  |                   | 40         |                  |
| $T_C = 100^\circ\text{C}$   |                   | 20         |                  |
| Pulsed collector current, $t_p$ limited by $T_{jmax}$   | $I_{Cpuls}$       | 80         |                  |
| Turn off safe operating area<br>$V_{CE} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$  | -                 | 80         |                  |
| Gate-emitter voltage  | $V_{GE}$          | $\pm 20$   | V                |
| Avalanche energy, single pulse<br>$I_C = 20\text{ A}$ , $V_{CC} = 50\text{ V}$ , $R_{GE} = 25\ \Omega$ ,<br>start at $T_j = 25^\circ\text{C}$ | $E_{AS}$          | 115        | mJ               |
| Short circuit withstand time <sup>2</sup><br>$V_{GE} = 15\text{V}$ , $V_{CC} \leq 600\text{V}$ , $T_j \leq 150^\circ\text{C}$                 | $t_{SC}$          | 10         | $\mu$ s          |
| Power dissipation<br>$T_C = 25^\circ\text{C}$   | $P_{tot}$         | 179        | W                |
| Operating junction and storage temperature  | $T_j$ , $T_{stg}$ | -55...+150 | $^\circ\text{C}$ |
| Soldering temperature,<br>wavesoldering, 1.6mm (0.063 in.) from case for 10s  | $T_s$             | 260        |                  |

<sup>1</sup> J-STD-020 and JESD-022

<sup>2</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

### Thermal Resistance

| Parameter                                | Symbol     | Conditions                      | Max. Value | Unit |
|--|------------|---------------------------------|------------|------|
| <b>Characteristic</b>                    |            |                                 |            |      |
| IGBT thermal resistance, junction – case | $R_{thJC}$ |                                 | 0.7        | K/W  |
| Thermal resistance, junction – ambient   | $R_{thJA}$ | PG-TO-220-3-1<br>PG-TO-247-3-21 | 62<br>40   |      |

### Electrical Characteristic, at $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter  | Symbol        | Conditions  | Value    |          |            | Unit    |
|--|---------------|---|----------|----------|------------|---------|
|  |               |   | min.     | Typ.     | max.       |         |
| <b>Static Characteristic</b>                                   |               |   |          |          |            |         |
| Collector-emitter breakdown voltage                            | $V_{(BR)CES}$ | $V_{GE}=0V, I_C=500\mu A$   | 600      | -        | -          | V       |
| Collector-emitter saturation voltage                           | $V_{CE(sat)}$ | $V_{GE} = 15V, I_C=20A$<br>$T_j=25^\circ\text{C}$<br>$T_j=150^\circ\text{C}$          | 1.7<br>- | 2<br>2.4 | 2.4<br>2.9 |         |
| Gate-emitter threshold voltage                                 | $V_{GE(th)}$  | $I_C=700\mu A, V_{CE}=V_{GE}$   | 3        | 4        | 5          |         |
| Zero gate voltage collector current                            | $I_{CES}$     | $V_{CE}=600V, V_{GE}=0V$<br>$T_j=25^\circ\text{C}$<br>$T_j=150^\circ\text{C}$         | -<br>-   | -<br>-   | 40<br>2500 | $\mu A$ |
| Gate-emitter leakage current                                   | $I_{GES}$     | $V_{CE}=0V, V_{GE}=20V$   | -        | -        | 100        | nA      |
| Transconductance   | $g_{fs}$      | $V_{CE}=20V, I_C=20A$   | -        | 14       | -          | S       |
| <b>Dynamic Characteristic</b>                                  |               |   |          |          |            |         |
| Input capacitance  | $C_{iss}$     | $V_{CE}=25V,$<br>$V_{GE}=0V,$<br>$f=1\text{MHz}$                                      | -        | 1100     | 1320       | pF      |
| Output capacitance   | $C_{oss}$     |   | -        | 107      | 128        |         |
| Reverse transfer capacitance                                   | $C_{riss}$    |   | -        | 63       | 76         |         |
| Gate charge  | $Q_{Gate}$    | $V_{CC}=480V, I_C=20A$<br>$V_{GE}=15V$  | -        | 100      | 130        | nC      |
| Internal emitter inductance measured 5mm (0.197 in.) from case | $L_E$         | PG-TO-220-3-1<br>PG-TO-247-3-21   | -<br>-   | 7<br>13  | -<br>-     | nH      |
| Short circuit collector current <sup>2)</sup>                  | $I_{C(SC)}$   | $V_{GE}=15V, t_{SC}\leq 10\mu s$<br>$V_{CC}\leq 600V,$<br>$T_j\leq 150^\circ\text{C}$ | -        | 200      | -          | A       |

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

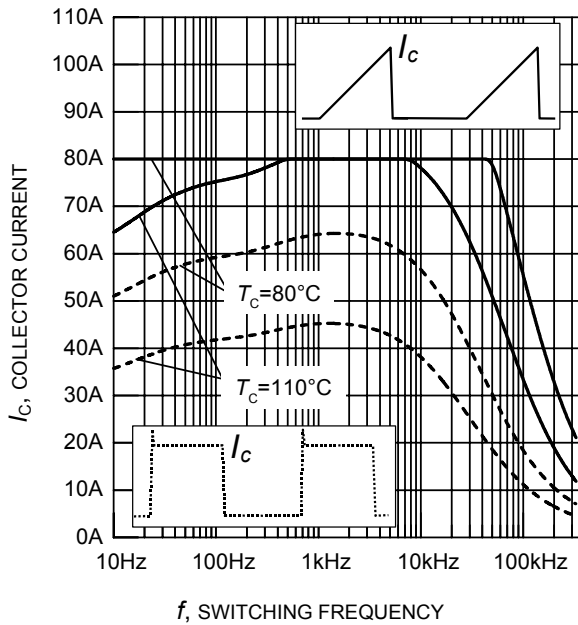
### Switching Characteristic, Inductive Load, at $T_j=25^\circ\text{C}$

| Parameter                  | Symbol              | Conditions   | Value |      |      | Unit |
|----------------------------|---------------------|--|-------|------|------|------|
|                            |                     |  | min.  | typ. | max. |      |
| <b>IGBT Characteristic</b> |                     |  |       |      |      |      |
| Turn-on delay time         | $t_{d(\text{on})}$  | $T_j=25^\circ\text{C}$ ,<br>$V_{\text{CC}}=400\text{V}$ , $I_{\text{C}}=20\text{A}$ ,<br>$V_{\text{GE}}=0/15\text{V}$ ,<br>$R_{\text{G}}=16\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=900\text{pF}$<br>Energy losses include<br>"tail" and diode<br>reverse recovery. | -     | 36   | 46   | ns   |
| Rise time                  | $t_{\text{r}}$      |  | -     | 30   | 36   |      |
| Turn-off delay time        | $t_{d(\text{off})}$ |  | -     | 225  | 270  |      |
| Fall time                  | $t_{\text{f}}$      |  | -     | 54   | 65   |      |
| Turn-on energy             | $E_{\text{on}}$     |  | -     | 0.44 | 0.53 | mJ   |
| Turn-off energy            | $E_{\text{off}}$    |  | -     | 0.33 | 0.43 |      |
| Total switching energy     | $E_{\text{ts}}$     |  | -     | 0.77 | 0.96 |      |

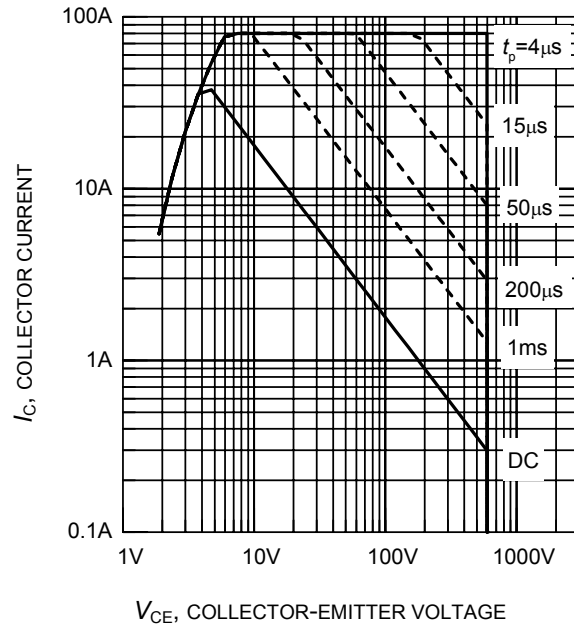
### Switching Characteristic, Inductive Load, at $T_j=150^\circ\text{C}$

| Parameter                  | Symbol              | Conditions  | Value |      |      | Unit |
|----------------------------|---------------------|---|-------|------|------|------|
|                            |                     |   | min.  | typ. | max. |      |
| <b>IGBT Characteristic</b> |                     |   |       |      |      |      |
| Turn-on delay time         | $t_{d(\text{on})}$  | $T_j=150^\circ\text{C}$<br>$V_{\text{CC}}=400\text{V}$ , $I_{\text{C}}=20\text{A}$ ,<br>$V_{\text{GE}}=0/15\text{V}$ ,<br>$R_{\text{G}}=16\Omega$ ,<br>$L_{\sigma}^{1)}=180\text{nH}$ ,<br>$C_{\sigma}^{1)}=900\text{pF}$<br>Energy losses include<br>"tail" and diode<br>reverse recovery. | -     | 36   | 46   | ns   |
| Rise time                  | $t_{\text{r}}$      |   | -     | 30   | 36   |      |
| Turn-off delay time        | $t_{d(\text{off})}$ |   | -     | 250  | 300  |      |
| Fall time                  | $t_{\text{f}}$      |   | -     | 63   | 76   |      |
| Turn-on energy             | $E_{\text{on}}$     |   | -     | 0.67 | 0.81 | mJ   |
| Turn-off energy            | $E_{\text{off}}$    |   | -     | 0.49 | 0.64 |      |
| Total switching energy     | $E_{\text{ts}}$     |   | -     | 1.12 | 1.45 |      |

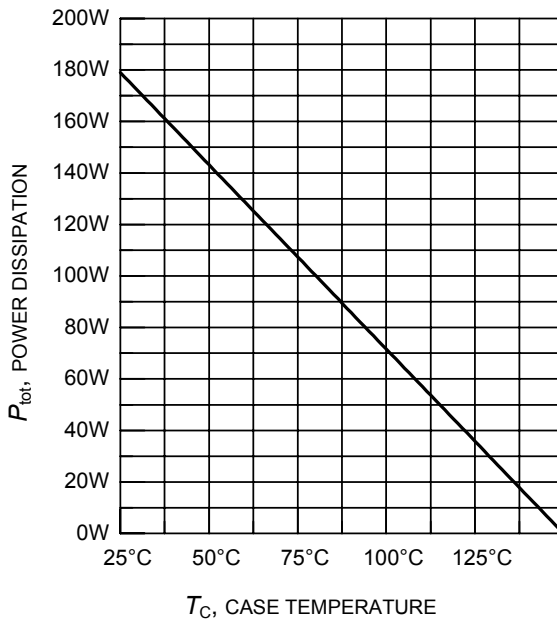
<sup>1)</sup> Leakage inductance  $L_{\sigma}$  and Stray capacity  $C_{\sigma}$  due to dynamic test circuit in Figure E.



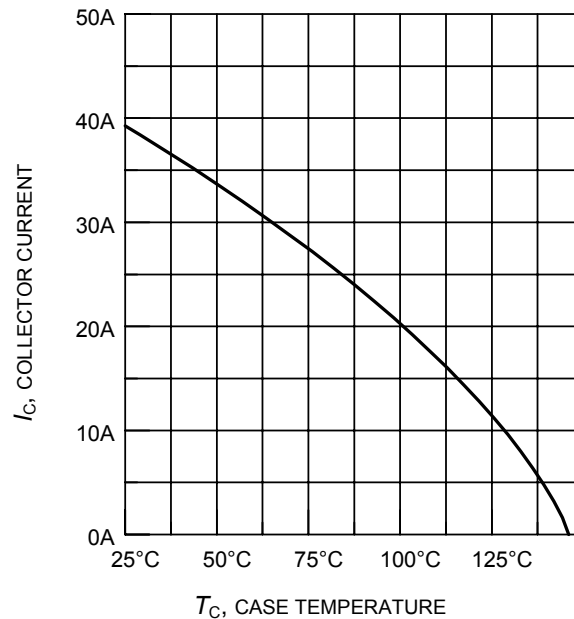
**Figure 1. Collector current as a function of switching frequency**  
 ( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 16\Omega$ )



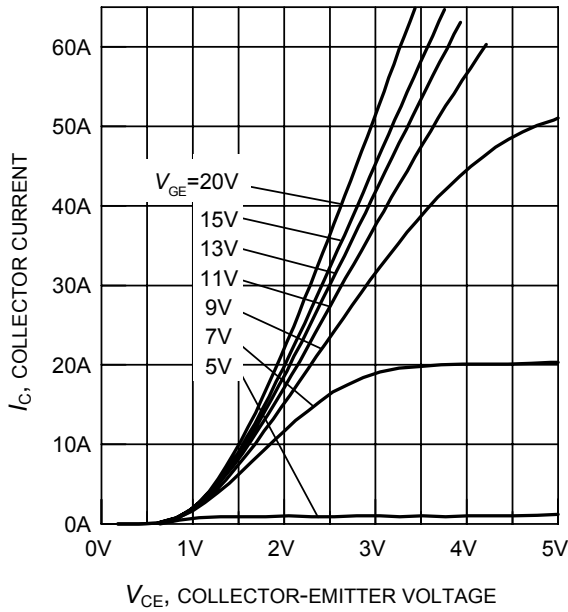
**Figure 2. Safe operating area**  
 ( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$ )



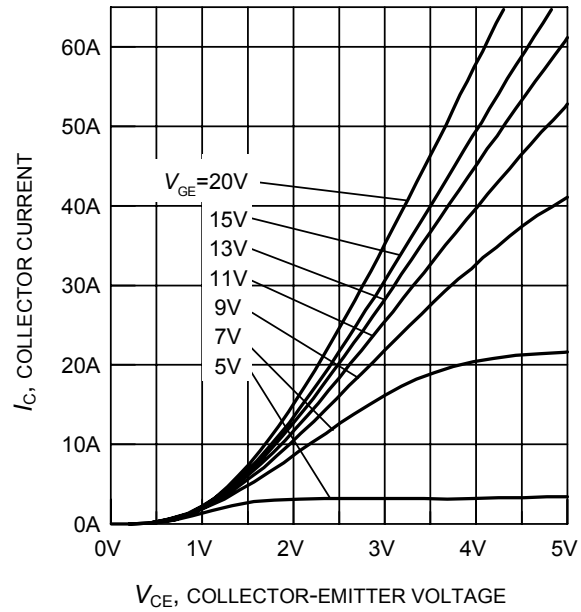
**Figure 3. Power dissipation as a function of case temperature**  
 ( $T_j \leq 150^\circ\text{C}$ )



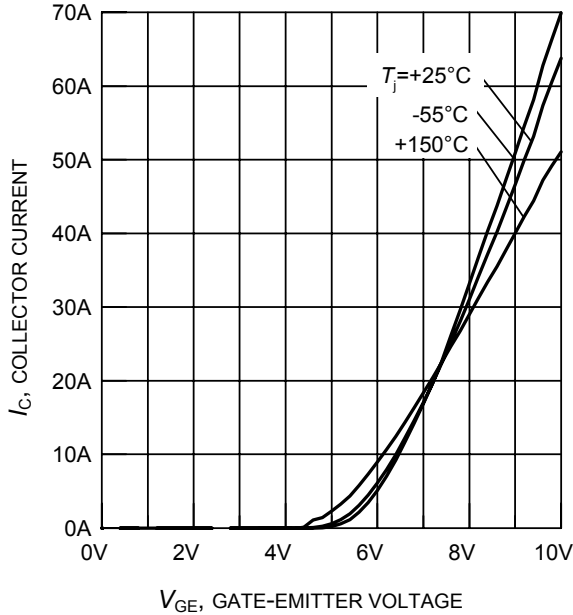
**Figure 4. Collector current as a function of case temperature**  
 ( $V_{GE} \leq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



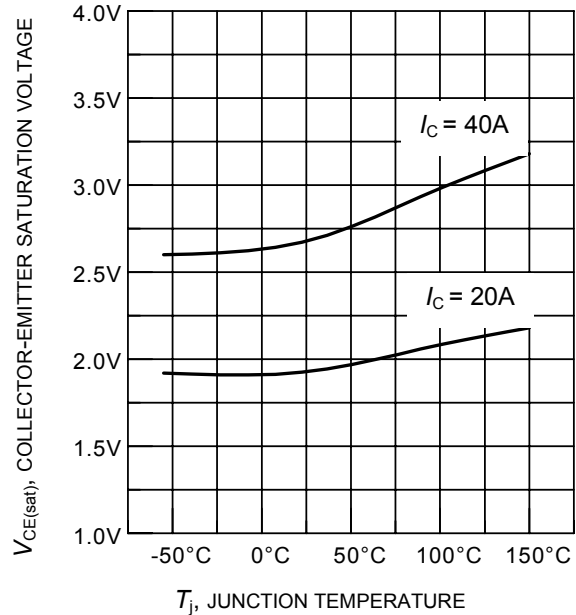
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



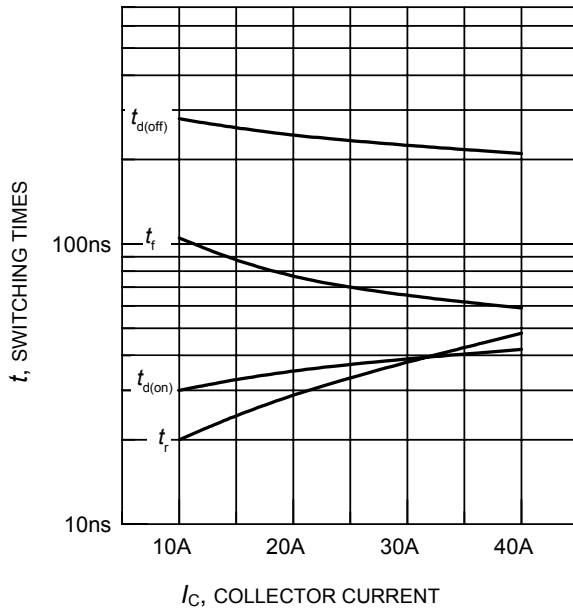
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



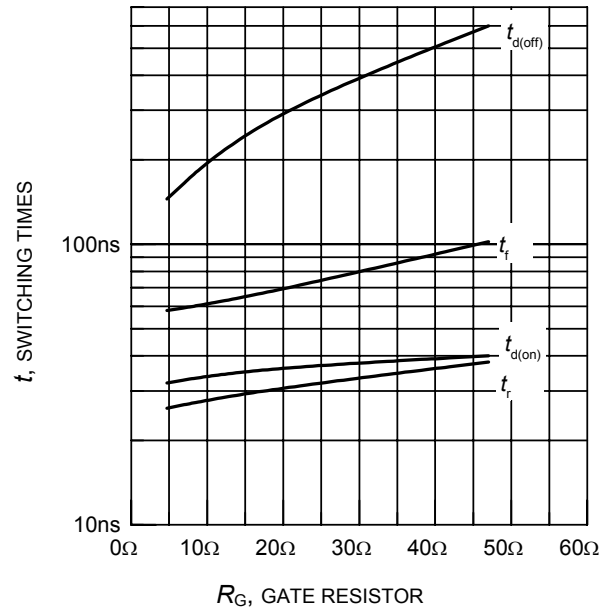
**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 10\text{V}$ )



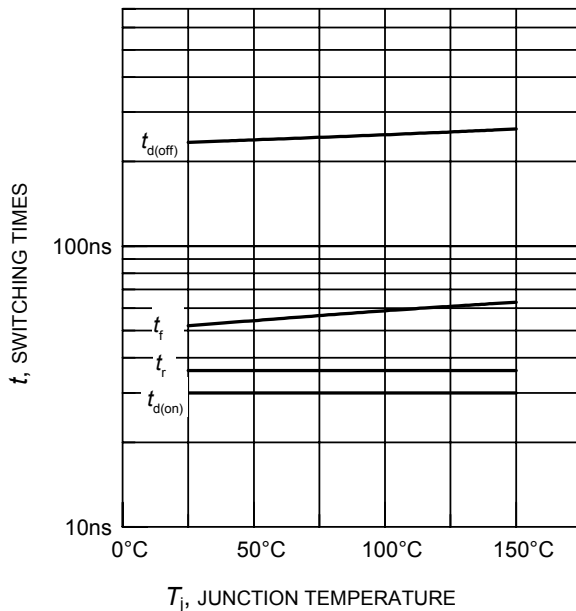
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



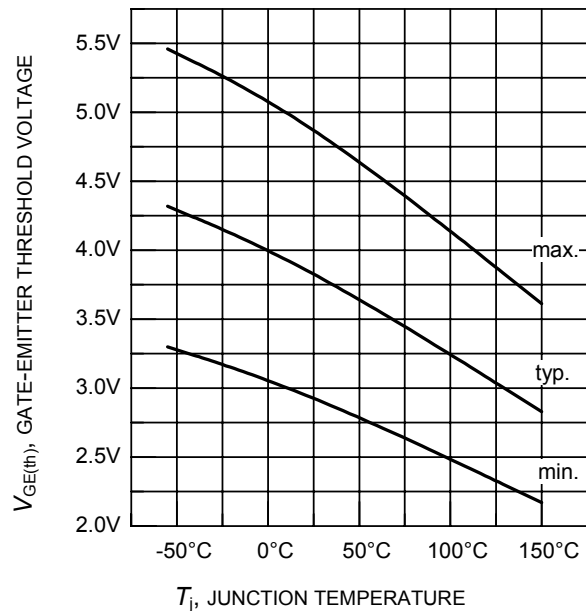
**Figure 9. Typical switching times as a function of collector current**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 16\Omega$ ,  
 Dynamic test circuit in Figure E)



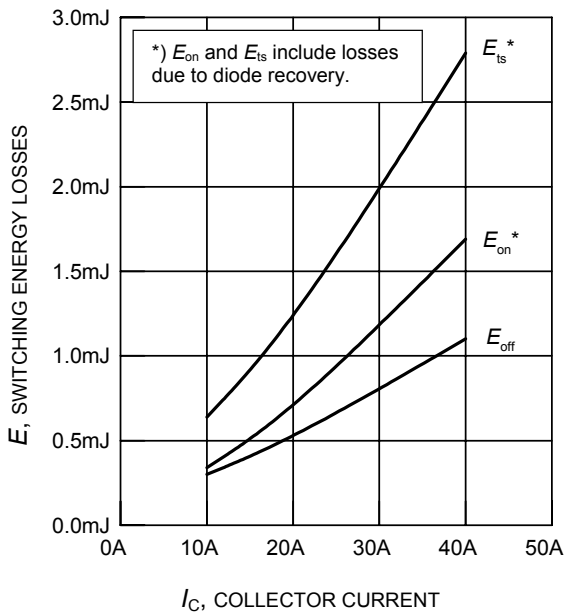
**Figure 10. Typical switching times as a function of gate resistor**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $I_C = 20\text{A}$ ,  
 Dynamic test circuit in Figure E)



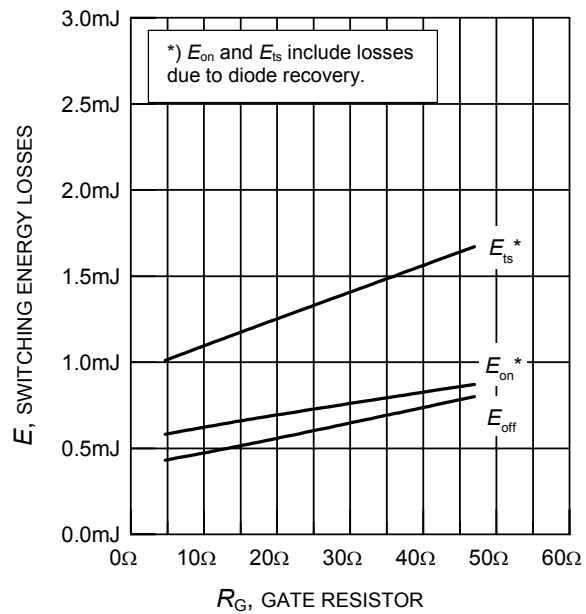
**Figure 11. Typical switching times as a function of junction temperature**  
 (inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  
 $I_C = 20\text{A}$ ,  $R_G = 16\Omega$ ,  
 Dynamic test circuit in Figure E)



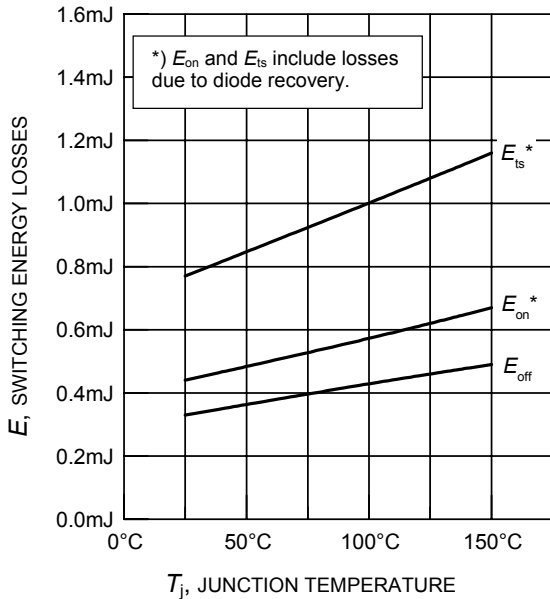
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
 ( $I_C = 0.7\text{mA}$ )



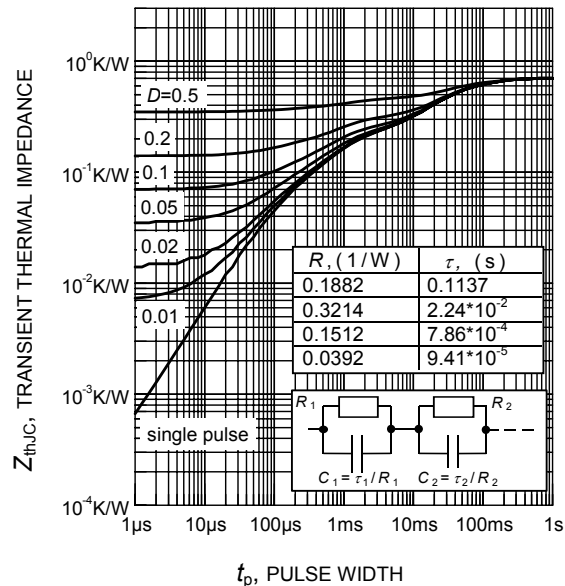
**Figure 13. Typical switching energy losses as a function of collector current**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $R_G = 16\Omega$ , Dynamic test circuit in Figure E)



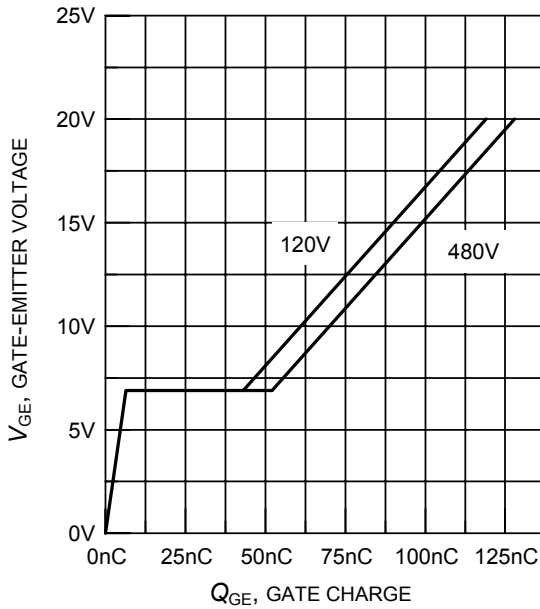
**Figure 14. Typical switching energy losses as a function of gate resistor**  
 (inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 20\text{A}$ , Dynamic test circuit in Figure E)



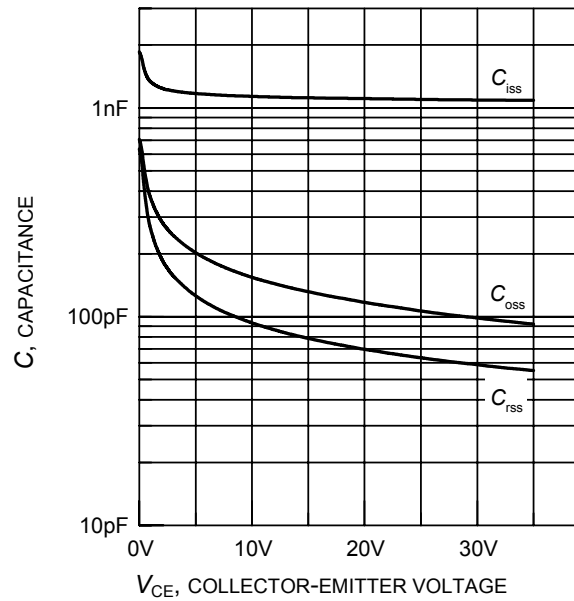
**Figure 15. Typical switching energy losses as a function of junction temperature**  
 (inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  $I_C = 20\text{A}$ ,  $R_G = 16\Omega$ , Dynamic test circuit in Figure E)



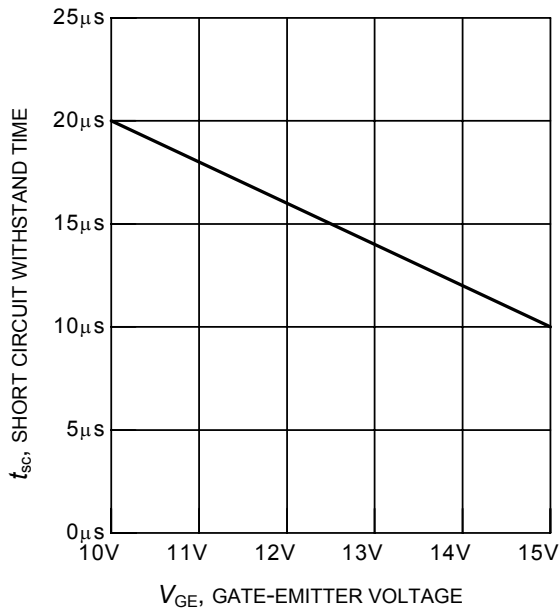
**Figure 16. IGBT transient thermal impedance as a function of pulse width**  
 ( $D = t_p / T$ )



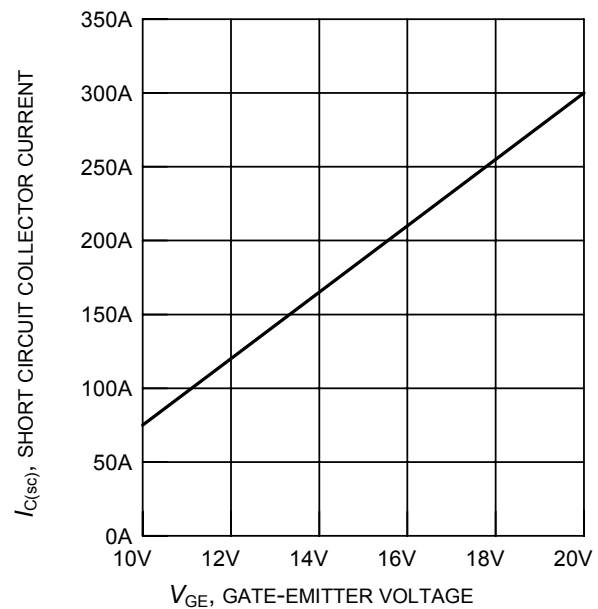
**Figure 17. Typical gate charge**  
( $I_C = 20A$ )



**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE} = 0V$ ,  $f = 1MHz$ )



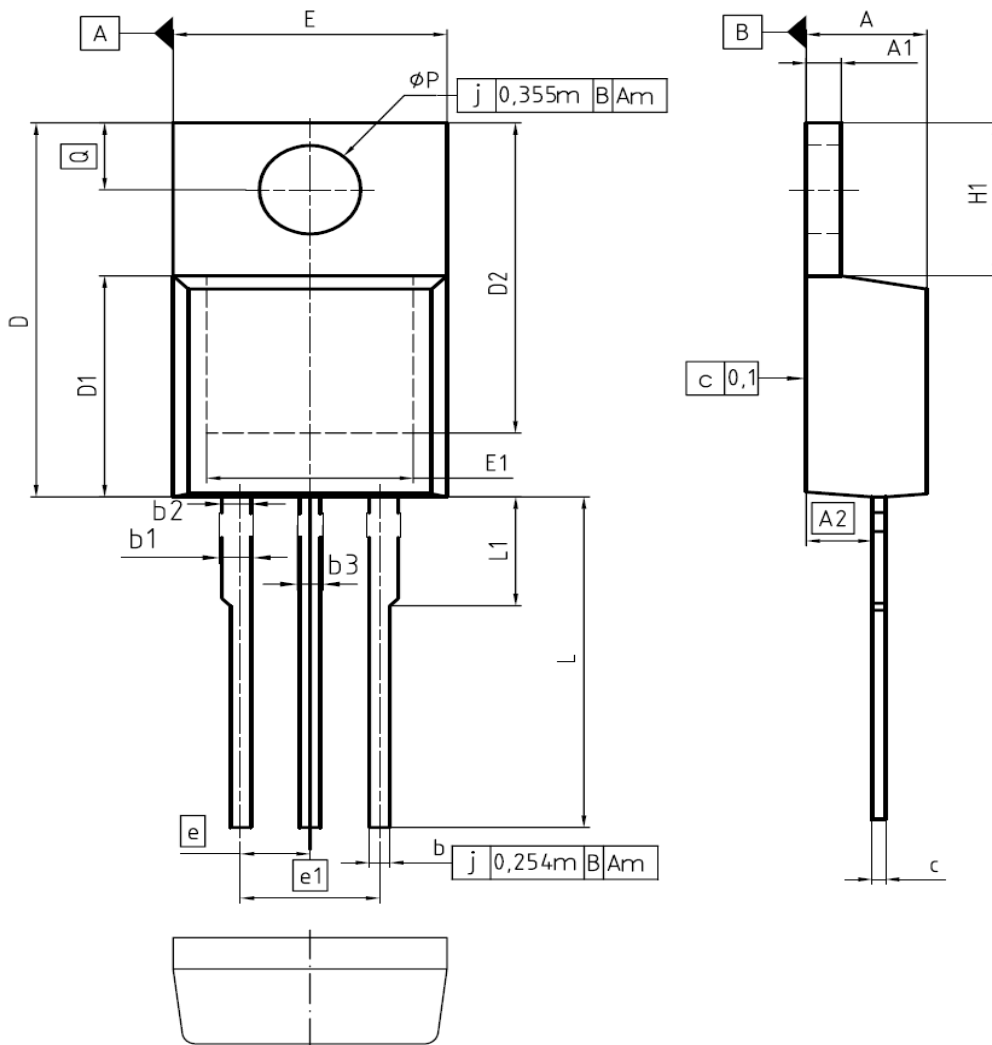
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE} = 600V$ , start at  $T_j = 25^\circ C$ )



**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 600V$ ,  $T_j = 150^\circ C$ )



PG-TO220-3-1



| DIM | MILLIMETERS |       | INCHES |       |
|-----|-------------|-------|--------|-------|
|     | MIN         | MAX   | MIN    | MAX   |
| A   | 4.30        | 4.57  | 0.169  | 0.180 |
| A1  | 1.17        | 1.40  | 0.046  | 0.055 |
| A2  | 2.15        | 2.72  | 0.085  | 0.107 |
| b   | 0.65        | 0.86  | 0.026  | 0.034 |
| b1  | 0.95        | 1.40  | 0.037  | 0.055 |
| b2  | 0.95        | 1.15  | 0.037  | 0.045 |
| b3  | 0.65        | 1.15  | 0.026  | 0.045 |
| c   | 0.33        | 0.60  | 0.013  | 0.024 |
| D   | 14.81       | 15.95 | 0.583  | 0.628 |
| D1  | 8.51        | 9.45  | 0.335  | 0.372 |
| D2  | 12.19       | 13.10 | 0.480  | 0.516 |
| E   | 9.70        | 10.36 | 0.382  | 0.408 |
| E1  | 6.50        | 8.60  | 0.256  | 0.339 |
| e   | 2.54        |       | 0.100  |       |
| e1  | 5.08        |       | 0.200  |       |
| N   | 3           |       | 3      |       |
| H1  | 5.90        | 6.90  | 0.232  | 0.272 |
| L   | 13.00       | 14.00 | 0.512  | 0.551 |
| L1  | -           | 4.80  | -      | 0.189 |
| φP  | 3.60        | 3.89  | 0.142  | 0.153 |
| Q   | 2.60        | 3.00  | 0.102  | 0.118 |

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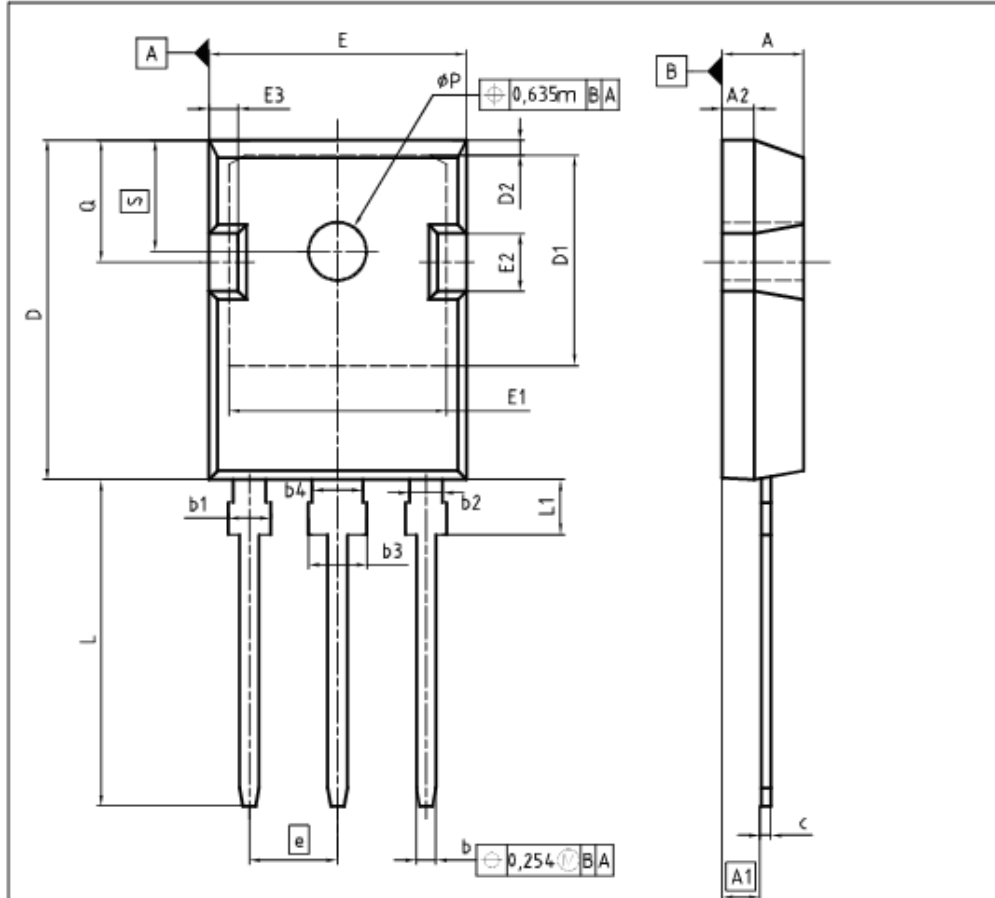
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EUROPEAN PROJECTION

ISSUE DATE  
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REVISION  
05

T0247-3



| DIM   | MILLIMETERS |       | INCHES |       |
|-------|-------------|-------|--------|-------|
|       | MIN         | MAX   | MIN    | MAX   |
| A     | 4.63        | 5.21  | 0.180  | 0.205 |
| A1    | 2.27        | 2.54  | 0.089  | 0.100 |
| A2    | 1.85        | 2.16  | 0.073  | 0.085 |
| b     | 1.07        | 1.33  | 0.042  | 0.052 |
| b1    | 1.90        | 2.41  | 0.075  | 0.095 |
| b2    | 1.90        | 2.16  | 0.075  | 0.085 |
| b3    | 2.87        | 3.38  | 0.113  | 0.133 |
| b4    | 2.87        | 3.13  | 0.113  | 0.123 |
| c     | 0.55        | 0.68  | 0.022  | 0.027 |
| D     | 20.80       | 21.10 | 0.819  | 0.831 |
| D1    | 16.25       | 17.85 | 0.640  | 0.695 |
| D2    | 0.95        | 1.35  | 0.037  | 0.053 |
| E     | 15.70       | 16.13 | 0.618  | 0.635 |
| E1    | 13.10       | 14.15 | 0.516  | 0.557 |
| E2    | 3.68        | 5.10  | 0.145  | 0.201 |
| E3    | 1.00        | 2.60  | 0.039  | 0.102 |
| e     | 5.44        |       | 0.214  |       |
| N     | 3           |       | 3      |       |
| L     | 19.80       | 20.32 | 0.780  | 0.800 |
| L1    | 4.10        | 4.47  | 0.161  | 0.176 |
| phi P | 3.50        | 3.70  | 0.138  | 0.146 |
| Q     | 5.49        | 6.00  | 0.216  | 0.236 |
| S     | 6.04        | 6.30  | 0.238  | 0.248 |

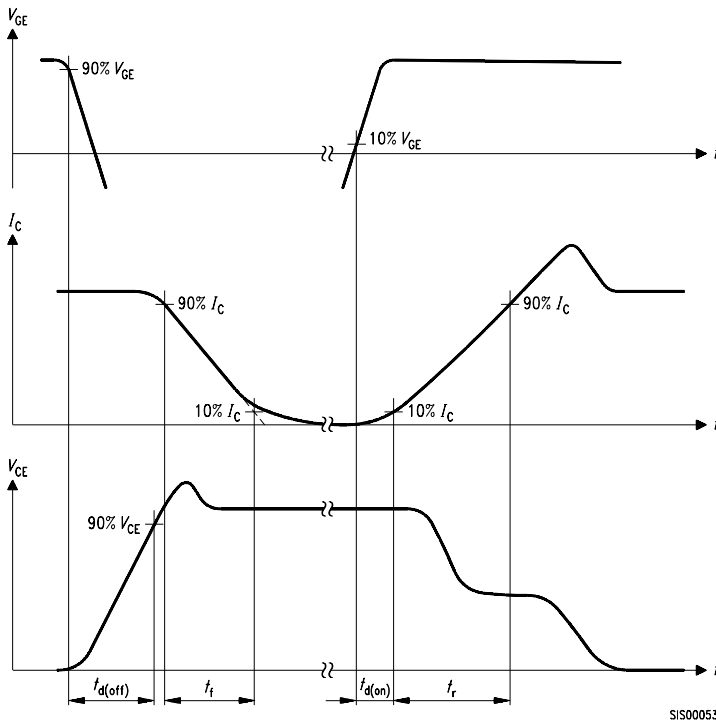
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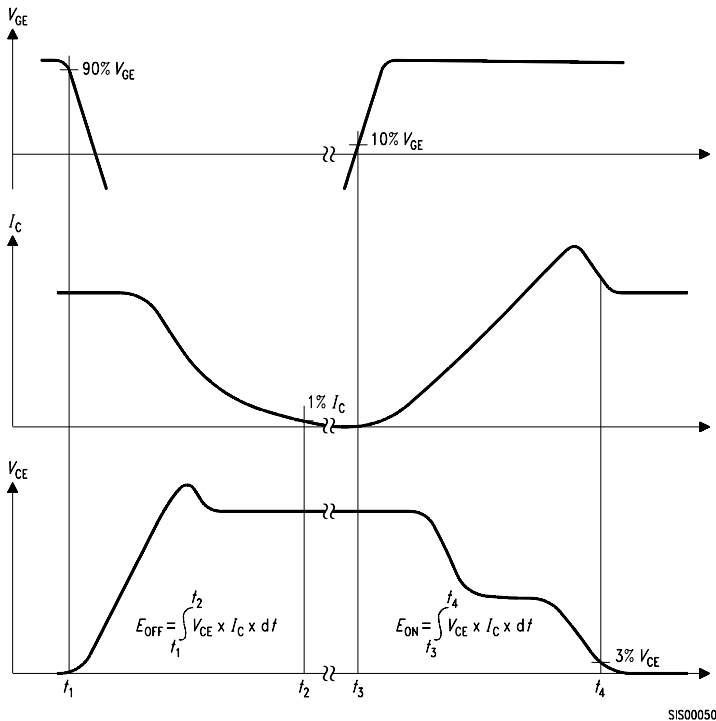
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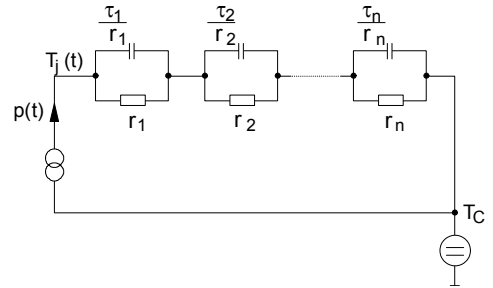
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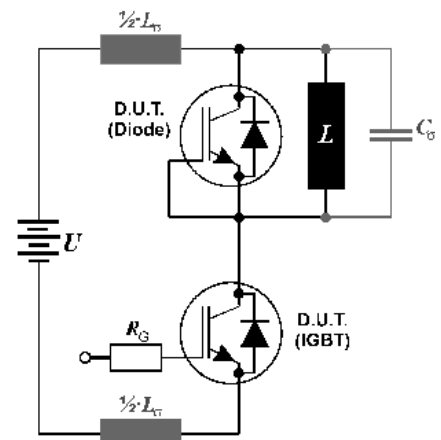
**Figure A. Definition of switching times**



**Figure B. Definition of switching losses**



**Figure D. Thermal equivalent circuit**



**Figure E. Dynamic test circuit**  
Leakage inductance  $L_\sigma = 180\text{nH}$   
and Stray capacity  $C_\sigma = 900\text{pF}$ .

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Электрон  
Связь**

Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию .

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России , а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научно-исследовательскими институтами России.

С нами вы становитесь еще успешнее!

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